# mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



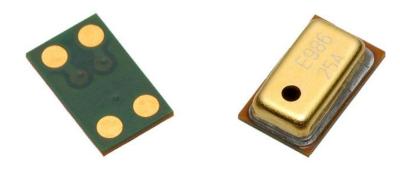
### Contact us

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### Slim UltraMini SiSonic<sup>™</sup> Microphone



The SPQ0410HR5H-B is a miniature, highperformance, low power, top port silicon microphone. Using Knowles' proven high performance SiSonic<sup>™</sup> MEMS technology, the SPQ0410HR5H-B consists of an acoustic sensor, a low noise input buffer, and an output amplifier. These devices are suitable for applications such as cellphones, smart phones, laptop computers, sensors, digital still cameras, portable music recorders, and other portable electronic devices where excellent wideband audio performance and RF immunity are required.

#### Features:

- Extremely narrow package
- Low Current
- MaxRF protection
- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional



#### 1. ABSOLUTE MAXIMUM RATINGS

Parameter	Absolute Maximum Rating	Units
$V_{\text{DD}}$ to Ground	-0.5, +5.0	V
OUT to Ground	-0.3, V <sub>DD</sub> + 0.3	V
Input Current to Any Pin	±5	mA
Temperature Range	-40 to +100	°C

Stresses exceeding these "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications" is not implied. Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

#### 2. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: 23 ±2°C, 55±20% R.H., V<sub>DD</sub>(min) < V<sub>DD</sub> < V<sub>DD</sub>(max), no load, unless otherwise indicated

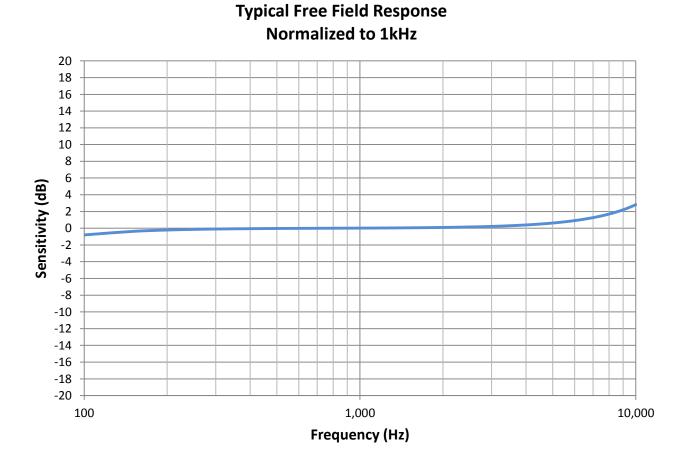
Parameter	Symbol	Conditions	Min	Тур	Max	Units
Supply Voltage <sup>1</sup>	$V_{\text{DD}}$		1.5	-	3.6	V
Supply Current <sup>1,2</sup>	I <sub>DD</sub>		-	120	160	μA
Sensitivity <sup>1</sup>	S	94 dB SPL @ 1 kHz	-45	-42	-39	dBV/Pa
Signal to Noise Ratio	SNR	94 dB SPL @ 1 kHz, A-weighted	-	59	-	dB(A)
Total Harmonic Distortion	THD	94 dB SPL @ 1 kHz, S = Typ, R <sub>load</sub> > 3 kΩ	-	-	1	%
Acoustic Overload Point	AOP	10% THD @ 1 kHz, S = Typ, V_{DD} = 3.6V, R_{load} > 3 k\Omega	115	-	-	dB SPL
DC Output		V <sub>DD</sub> = 1.5V	-	0.73	-	V
Output Impedance	Z <sub>OUT</sub>	@ 1 kHz	-	-	400	Ω
Directivity			Omnidirectional			
Polarity		Increasing sound pressure	Decreasing output voltage			

<sup>1</sup> 100% tested.

 $^2$  Maximum specifications are measured at maximum  $V_{\text{DD}}$ . Typical specifications are measured at  $V_{\text{DD}}$  = 1.8V.

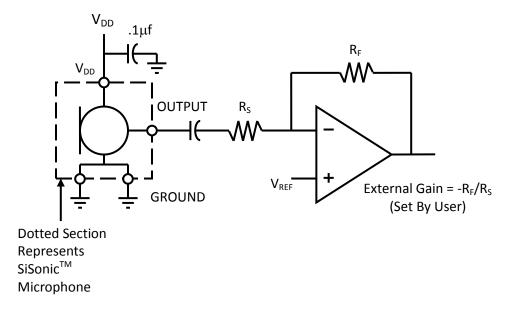


#### 3. FREQUENCY RESPONSE CURVE





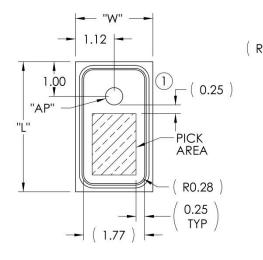
#### 4. INTERFACE CIRCUIT

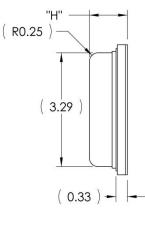


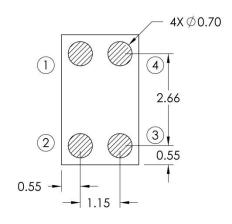
Note: All Ground pins must be connected to ground.
 Capacitors near the microphone should not contain Class 2 dielectrics.
 Detailed information on acoustic, mechanical, and system integration can be found in the latest SiSonic<sup>™</sup> Design Guide application note.



#### 5. MECHANICAL SPECIFICATIONS



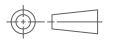




Item	Dimension	Tolerance
Length (L)	3.76	±0.10
Width (W)	2.24	±0.10
Height (H)	1.10	±0.10
Acoustic Port (AP)	Ø0.50	±0.05

Pin #	Pin Name	Туре	Description
1	$V_{\text{DD}}$	Power	Power Supply
2	GROUND	Power	Ground
3	GROUND	Power	Ground
4	OUTPUT	Signal	Output Signal

Notes: Pick Area only extends to 0.25 mm of any edge or hole unless otherwise specified.

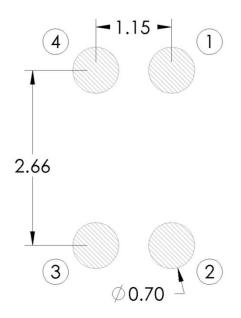


Dimensions are in millimeters unless otherwise specified. Tolerance is ±0.15mm unless otherwise specified

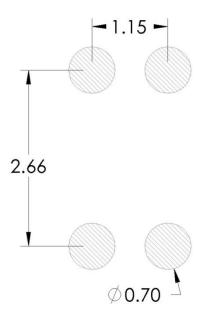
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#### 6. EXAMPLE LAND PATTERN



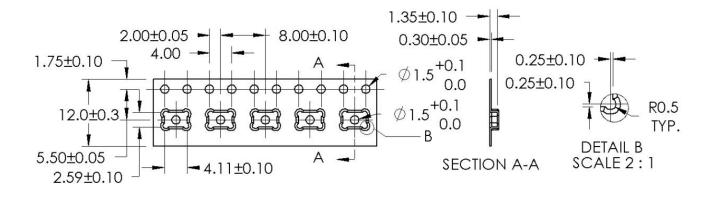
#### 7. EXAMPLE SOLDER STENCIL PATTERN



Notes: Dimensions are in millimeters unless otherwise specified. Further optimizations based on application should be performed.



#### 8. PACKAGING & MARKING DETAIL



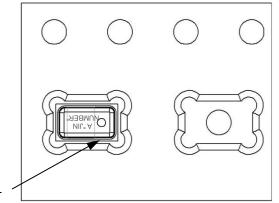
Model Number	Suffix	Reel Diameter	Quantity Per Reel
SPQ0410HR5H-B	-7	13"	5,700

Alpha Character A:

"S": Knowles SiSonic<sup>™</sup> Production "E": Knowles Engineering Samples "P": Knowles Prototype Samples

"JIN NUMBER":

Unique Job Identification Number for product traceability Pin 1



Notes: Dimensions are in millimeters unless otherwise specified.

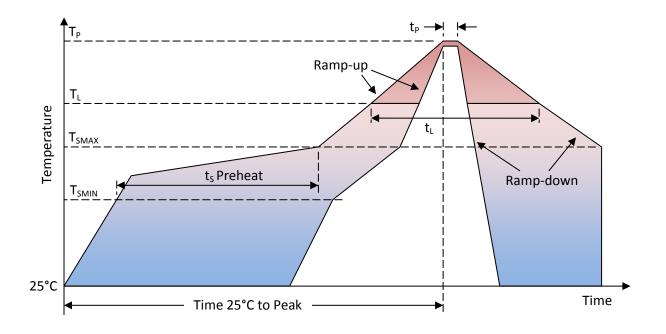
Vacuum pickup only in the pick area indicated in Mechanical Specifications. Tape & reel per EIA-481.

Labels applied directly to reel and external package.

Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.



#### 9. RECOMMENDED REFLOW PROFILE



Profile Feature	Pb-Free	
Average Ramp-up rate $(T_{SMAX} \text{ to } T_P)$	3°C/second max.	
Preheat		
• Temperature Min (T <sub>SMIN</sub> )	150°C	
• Temperature Max (T <sub>SMAX</sub> )	200°C	
• Time (T <sub>SMIN</sub> to T <sub>SMAX</sub> ) (t <sub>s</sub> )	60-180 seconds	
Time maintained above:		
<ul> <li>Temperature (T<sub>L</sub>)</li> </ul>	217°C	
• Time (t <sub>L</sub> )	60-150 seconds	
Peak Temperature (T <sub>P</sub> )	260°C	
Time within $5^{\circ}$ C of actual Peak Temperature ( $t_{P}$ )	20-40 seconds	
Ramp-down rate ( $T_P$ to $T_{SMAX}$ )	6°C/second max	
Time 25°C to Peak Temperature	8 minutes max	

#### Notes: Based on IPC/JDEC J-STD-020 Revision C.

All temperatures refer to topside of the package, measured on the package body surface.



#### **10. ADDITIONAL NOTES**

(A) MSL (moisture sensitivity level) Class 1.

- (B) Maximum of 3 reflow cycles is recommended.
- (C) In order to minimize device damage:
  - Do not board wash or clean after the reflow process.
  - Do not brush board with or without solvents after the reflow process.
  - Do not directly expose to ultrasonic processing, welding, or cleaning.
  - Do not insert any object in port hole of device at any time.
  - Do not apply over 30 psi of air pressure into the port hole.
  - Do not pull a vacuum over port hole of the microphone.
  - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.

#### **11. MATERIALS STATEMENT**

Meets the requirements of the European RoHS directive 2011/65/EC as amended.

Meets the requirements of the industry standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.

Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in Annex A, B, and C of the "Montreal Protocol on Substances That Deplete the Ozone Layer."



#### **12. RELIABILITY SPECIFICATIONS**

Test	Description
Thermal Shock	100 cycles air-to-air thermal shock from -40°C to +125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature Storage	1,000 hours at +105°C environment (IEC 68-2-2 Test Ba)
Low Temperature Storage	1,000 hours at -40°C environment (IEC 68-2-2 Test Aa)
High Temperature Bias	1,000 hours at +105°C under bias (IEC 68-2-2 Test Ba)
Low Temperature Bias	1,000 hours at -40°C under bias (IEC 68-2-2 Test Aa)
Temperature / Humidity Bias	1,000 hours at +85°C/85% R.H. under bias. (JESD22-A101A-B)
Vibration	4 cycles of 20 to 2,000 Hz sinusoidal sweep with 20 G peak acceleration lasting 12 minutes in X, Y, and Z directions. (Mil-Std-883E, Method 2007.2 A)
ESD-HBM	3 discharges of ±2 kV direct contact to I/O pins. (MIL 883E, Method 3015.7)
ESD-LID/GND	3 discharges of ±8 kV direct contact to lid while unit is grounded. (IEC 61000-4-2)
ESD-MM	3 discharges of ±200 V direct contact to I/O pins. (ESD STM5.2)
Reflow	5 reflow cycles with peak temperature of +260°C
Mechanical Shock	3 pulses of 10,000 G in the X, Y, and Z direction (IEC 68-2-27, Test Ea)

Note: After reliability tests are performed, the sensitivity of the microphones shall not deviate more than 3 dB from its initial value.



#### **13. SPECIFICATION REVISIONS**

Revision	Specification Changes	Date
А	Initial Release (C10112979)	11/11/11
В	Released in new format; add DC Output; corrected base thickness; new JIN designation; new RoHS statement (C10114438)	12/17/12
С	Updated humidity conditions and ESD descriptions (C10114466); moved Shelf Life information to Section 8	2/28/13
D	Fixed typos in Reliability Section 12 (C10114690)	3/27/13

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